



BAW156TQ

SURFACE MOUNT LOW LEAKAGE DIODE

Features

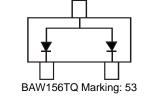
- Ultra-Small Surface Mount Package
- Very Low Leakage Current
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOT523
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 Leadframe).
- Polarity: See Diagram Below
- Marking Information: See Below
- Ordering Information: See Below
- Weight: 0.002 grams (Approximate)
- SOT523



Top View



Ordering Information (Note 5)

Part Number	Case	Packaging
BAW156TQ-7-F	SOT523	3,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

and Lead-free

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/quality/product_compliance_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



XX = Product Type Marking Code ("53" for BAW156TQ) YM = Date Code Marking Y = Year (ex: E = 2017) M = Month (ex: 9 = September)

Date Code Key												
Year	2017	,	2018	2019	2	2020	2021	2	022	2023		2024
Code	E		F	G		Н			J	K		L
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	85	V
RMS Reverse Voltage		V _{R(RMS)}	60	V
Forward Continuous Current (Note 6)	Single Diode Double Diode	I _{FM}	215 125	mA
Repetitive Peak Forward Current		I _{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0ms @ t = 1.0s	I _{FSM}	4.0 1.0 0.5	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	150	mW
Thermal Resistance Junction to Ambient Air (Note 6)	R _{0JA}	833	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-65 to +150	C°

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	85	_		V	I _R = 100μA
Forward Voltage	V _F	_	_	0.90 1.0 1.1 1.25	V	$I_{F} = 1.0mA$ $I_{F} = 10mA$ $I_{F} = 50mA$ $I_{F} = 150mA$
Leakage Current (Note 7)	I _R		_	5.0 80	nA nA	V _R = 75V V _R = 75V, T _J = +150°C
Total Capacitance	CT		2	—	pF	$V_{R} = 0, f = 1.0MHz$
Reverse Recovery Time	t _{RR}		_	3.0	μs	$I_F = I_R = 10 \text{mA},$ $I_{RR} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

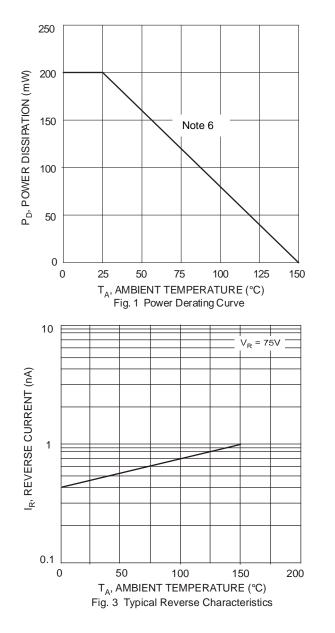
Notes:

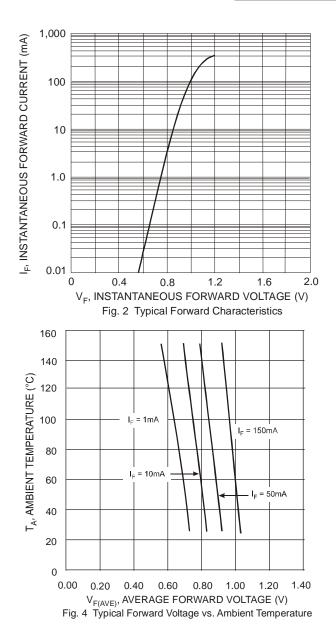
6. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at

http://www.diodes.com/package-outlines.html.

7. Short duration pulse test used to minimize self-heating effect.



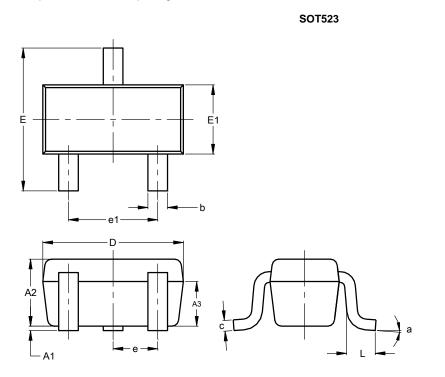






Package Outline Dimensions

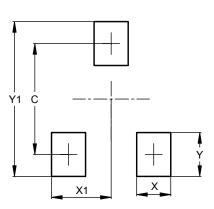
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT523						
Dim	Min Max Typ					
Α	0.60	0.80	0.75			
A1	0.00	0.10	0.05			
A3	0.45	0.65	0.50			
b	0.15	0.15 0.30 0.22				
С	0.10 0.20 0.1		0.12			
D	1.50	1.70	1.60			
E	1.45	1.75	1.60			
E1	0.75	0.85	0.80			
е	0.50 BSC					
e1	0.90	0.90 1.10 1.00				
L	0.20	0.40	0.33			
а	0°		8°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value
С	1.29
Х	0.40
X1	0.70
Y	0.51
Y1	1.80

SOT523



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